# UTC UNISONIC TECHNOLOGIES CO., LTD

5NM70Z-U2 **Power MOSFET** 

# 5.0A, 700V N-CHANNEL SUPER-JUNCTION MOSFET

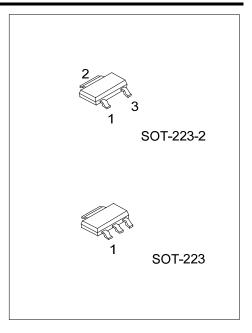
#### DESCRIPTION

The UTC 5NM70Z-U2 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics.

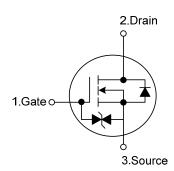
This power MOSFET is usually used in high speed switching applications at power supplies, PWM motor controls, high efficient AC to DC converters and bridge circuits.

#### **FEATURES**

- \*  $R_{DS(ON)} \le 1.5 \Omega$  @  $V_{GS}=10V$ ,  $I_{D}=1.0A$
- \* Fast Switching Capability
- \* Improved dv/dt Capability, High Ruggedness



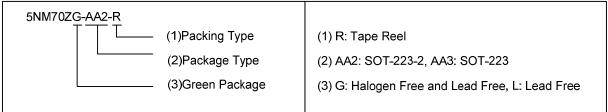
#### **SYMBOL**



#### **ORDERING INFORMATION**

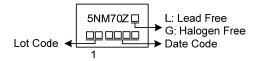
Ordering Number		Daalaaaa	Pin Assignment			Da akina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
5NM70ZL-AA2-R	5NM70ZG-AA2-R	SOT-223-2	G	D	S	Tape Reel	
5NM70ZL-AA3-R	5NM70ZG-AA3-R	SOT-223	G	D	S	Tape Reel	

Pin Assignment: G: Gate D: Drain S: Source



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## ■ MARKING



5NM70Z-U2 Power MOSFET

## ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	700	V	
Gate-Source Voltage		$V_{GSS}$	±20	V	
Drain Current	Continuous	$I_D$	5	Α	
	Pulsed (Note 2)	$I_{DM}$	20	Α	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	72	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.1	V/ns	
Power Dissipation		P <sub>D</sub>	5 (Note 5)	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 144mH,  $I_{AS}$  = 1.0A,  $V_{DD}$  = 50V,  $R_{G}$  = 25  $\Omega$  Starting  $T_{J}$  = 25°C
- 4.  $I_{SD} \le 5.0 A$ , di/dt  $\le 200 A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J$  = 25°C
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

#### **■ THERMAL DATA**

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θја	160	°C/W	
Junction to Case	θјς	25	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

# ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

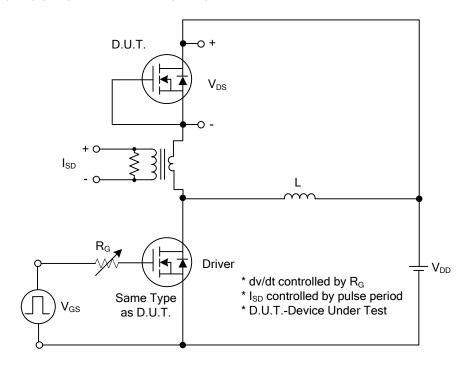
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	700			V		
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =700V, V <sub>GS</sub> =0V			10	μA		
Forward		V <sub>GS</sub> =20V, V <sub>DS</sub> =0V			10	μA		
Gate-Source Leakage Current Reverse	$I_{GSS}$	V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-10	μA		
ON CHARACTERISTICS								
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$			4.5	V		
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.0A		1.3	1.5	Ω		
DYNAMIC CHARACTERISTICS	_			-	ā.			
Input Capacitance	C <sub>ISS</sub>			278		рF		
Output Capacitance	Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =50V, f=1.0MHz		37		pF		
Reverse Transfer Capacitance	C <sub>RSS</sub>			3.5		рF		
Gate Resistance	$R_G$	V <sub>DS</sub> =0V, f=1.0MHz		4		Ω		
SWITCHING CHARACTERISTICS								
Total Gate Charge (Note 1)	$Q_{G}$	\/ -E60\/ \/ -10\/   -E 0A		10		nC		
Gate to Source Charge	$Q_GS$	V <sub>DS</sub> =560V, V <sub>GS</sub> =10V, I <sub>D</sub> =5.0A (Note 1, 2)		3.3		nC		
Gate to Drain Charge	$Q_{GD}$	(Note 1, 2)		2.2		nC		
Turn-ON Delay Time (Note 1)	t <sub>D(ON)</sub>			5.2		ns		
Rise Time	t <sub>R</sub>	V <sub>DD</sub> =100V, V <sub>GS</sub> =10V,		17		ns		
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	I <sub>D</sub> =5.0A, R <sub>G</sub> =25Ω (Note 1, 2)		36		ns		
Fall-Time	t⊧			29		ns		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current	ls				5	Α		
Maximum Body-Diode Pulsed Current	Ism				20	Α		
Drain-Source Diode Forward Voltage (Note 1)	V <sub>SD</sub>	I <sub>S</sub> =5.0A, V <sub>GS</sub> =0V			1.4	V		
Body Diode Reverse Recovery Time (Note 1)	t <sub>rr</sub>	I <sub>S</sub> =5.0A, V <sub>GS</sub> =0V,		280		ns		
Body Diode Reverse Recovery Charge	Qrr	dI <sub>F</sub> /dt=100A/μs		2.2		μC		

Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2%.

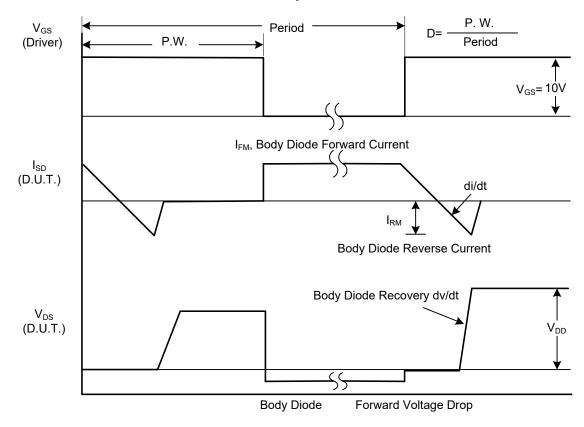
<sup>2.</sup> Essentially independent of operating temperature.

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#### **■ TEST CIRCUITS AND WAVEFORMS**



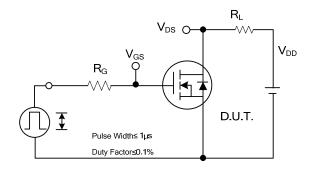
# Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

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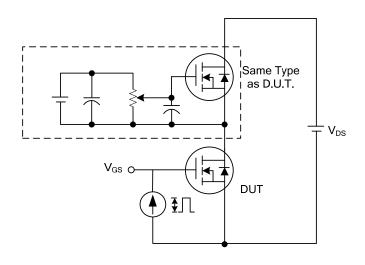
# ■ TEST CIRCUITS AND WAVEFORMS

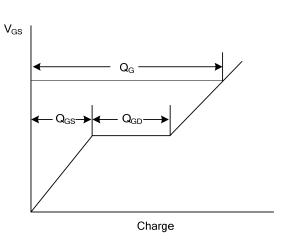


 $V_{DS}$   $V_{QS}$   $t_{D(ON)}$   $t_{D(OFF)}$   $t_{F}$ 

**Switching Test Circuit** 

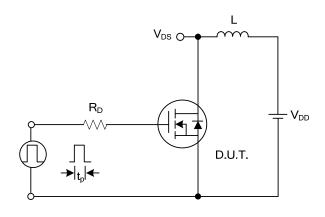
**Switching Waveforms** 

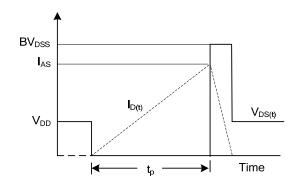




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 

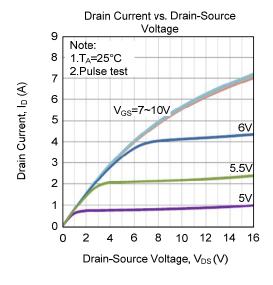


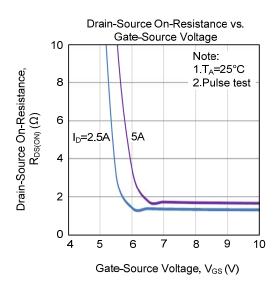


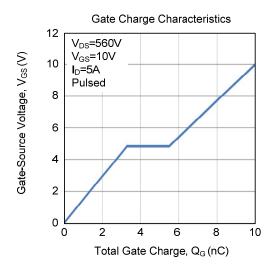
**Unclamped Inductive Switching Test Circuit** 

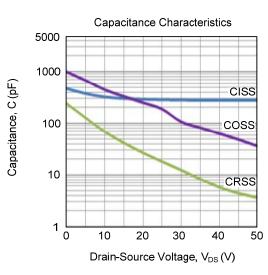
**Unclamped Inductive Switching Waveforms** 

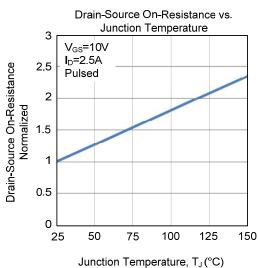
#### **■ TYPICAL CHARACTERISTICS**

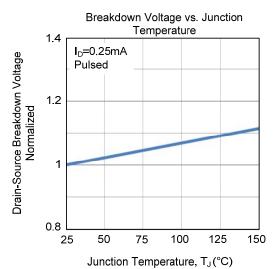




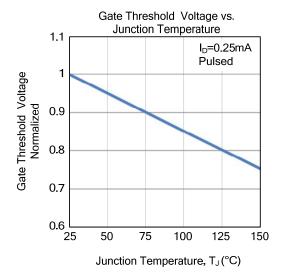


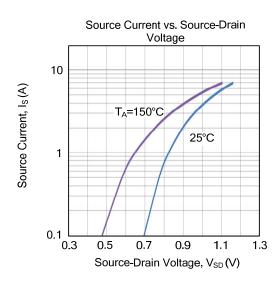


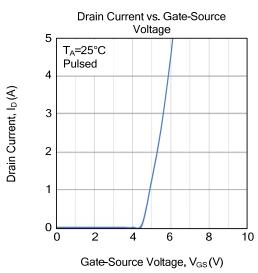


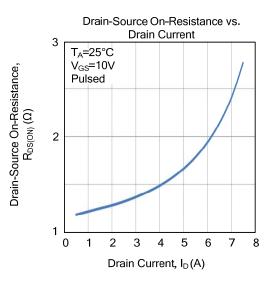


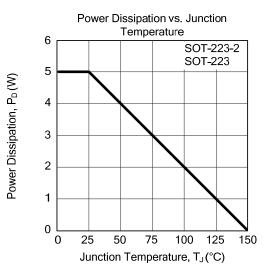
# **■ TYPICAL CHARACTERISTICS (Cont.)**

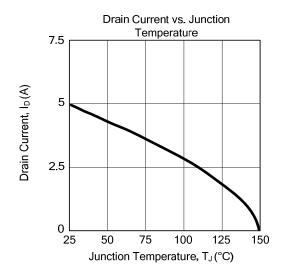




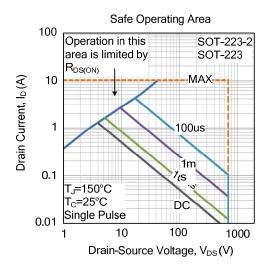








# **■ TYPICAL CHARACTERISTICS (Cont.)**



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